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SUBMISSION TYPE:			NEW ASSIGNMENT			
NATURE OF CONVEYANCE:			ASSIGNMENT			
CONVEYING PARTY DATA						
			lame	Execution Date		
Takao Shimomura				01/15/2008		
Hideki Tomoto				01/14/2008		
Masamitsu Sanada				01/14/2008		
RECEIVING PARTY DATA						
Name:	Eagle Industry Co.,Ltd.					
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City:	Minato-ku, Tokyo					
State/Country:	JAPAN					
Postal Code:	105-8587					
PROPERTY NUMBERS Total: 1						
Property Type			Number			
Application Number: 293		29302	Number			
CORRESPONDENCE DATA						
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ATTORNEY DOCKET NUMBER:			SHIG D01SE07EA DES			
NAME OF SUBMITTER:			Norman P. Soloway			
Total Attachments: 2 source=signed assignmnt 2.14.08#page1.tif						

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ASSIGNMENT

(Foreign - in the United States of America)

Takao Shimomura of <u>c/o Eagle Industry Co., Ltd., 1-12-15, Shiba-</u> I/we, Daimon, Minato-ku, Tokyo 105-8587 Japan ; Hideki Tomoto of _____ c/o Eagle Industry Co., Ltd., 1-12-15, Shiba-Daimon, Minato-ku, Tokyo 105-8587 Japan ; and Masamitsu Sanada of c/o Eagle Industry Co., Ltd., 1-12-15, Shiba-Daimon, Minato-ku, Tokyo 105-8587 SHAFT and having executed an application for Letters Patent of the United States of America describing the same and based thereon on the <u>25</u> day of <u>January</u>, 2008; day of ______, 2008 and _____ day of ______, 2008(and I/we hereby authorize our attorneys to prosecute said application, to here insert the filing date and serial number of said application, when known, Serial No. 29/302,860 ____, filed January 25,2008), for good and valuable consideration, the receipt of which is hereby acknowledged from <u>Eagle Industry Co., Ltd.</u>, an <u>Japanese</u> company having its principal place of business at ______7F, Seiwa Bldg., 1-12-15, Shiba-Daimon, Minato-ku, Tokyo 105-8587 Japan (hereinafter called the Assignee), do hereby sell, assign and transfer unto the Assignee, its successors, and assigns our entire right, title, and interest, in and to said invention in the United States of America, including all rights, title and interest in the abovementioned application and any divisional, continuing or reissue application or applications and any patent which may be issued on the said invention in the United States of America;

And for the same consideration I/we do agree that I/we will upon request execute any instrument which the Assignee may desire to carry this Assignment into effect and perfect the title transferred hereby or prosecute the above-mentioned application;

And I/we do hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America to issue Letters Patent on the said application to the Assignee;

And I/we do hereby jointly and severally covenant for ourselves and for our legal representatives that I/we have granted no right or license to make, use, or sell said inventions to anyone except the Assignee, that prior to the execution of this deed my right, title, and interest in

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and to said inventions or any of them or any part thereof has not been otherwise encumbered by us, and that I/we have not executed and will not execute any instrument in conflict herewith.

IN WITNESS WHEREOF, I/we hereunto set our hands and seals on the day and year hereinafter noted.

First Inventor's signature John Shimomure	Date <u>/S.1. 200</u>
Full name (typed or printed) <u>Takao Shimomura</u>	
Witness: <u>H. Akiba</u>	Witness: <u>Hideki AKIBA</u>
Date: Jon. 21, 2008	Witness: <u>Hideki AKIBA</u> Date: <u>January 21, 2008</u>
Second Inventor's signature <u>Hidehi Tomota</u>	Date 14. 1. 2008
Full name (typed or printed) <u>Hideki Tomoto</u>	Witness: Hidek: AKIBA
Witness: <u>H. Akiba</u> Date: <u>Jan 21, 2008</u>	T el cont
Date: <u>Jan 21, 2008</u>	Date
Third Inventor's signature <u>Masamitsu</u> Sa	
Full name (typed or printed) Masamitsu Sanac	$\frac{1a}{1}$
Witness: <u>H. Akiba</u> Date: <u>Jan. 21, 2008</u>	Witness: <u>Hideki ANIDA</u>
Date: Jan. 21, 2008	Date: <u>January 21, 2008</u>
	,

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